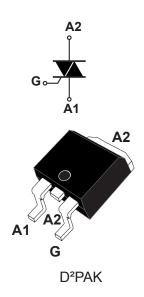




### Datasheet

## 30 A - 800 V - 150 °C 8H Triac in D<sup>2</sup>PAK





Product s	Product status link		
T3035H-8G			
Product	Product summary		
I <sub>T(RMS)</sub>	30 A		
V <sub>DRM</sub> /V <sub>RRM</sub>	800 V		
V <sub>DSM</sub> /V <sub>RSM</sub>	900 V		
I <sub>GT</sub>	35 mA		

#### **Features**

- 30 A high current Triac
- 800 V symmetrical blocking voltage
- 150 °C maximum junction temperature T<sub>i</sub>
- Three triggering quadrants
- High noise immunity static dV/dt
- Robust dynamic turn-off commutation (dl/dt)c
- ECOPACK2 compliant component

#### **Applications**

- Home automation Smart AC plug
- · Water heater, room heater and coffee machine
- AC Induction and Universal Motor control
- Inrush current limiter in AC DC rectifiers
- Lighting and automation I/O control
- General purpose AC line load control

### **Description**

Specifically designed to operate at 800 V and 150 °C, the T3035H-8G Triac housed in D<sup>2</sup>PAK provides an enhanced thermal management: this 30 A triac is the right choice for a compact drive of heavy AC loads and enables the heatsink size reduction.

Based on the ST Snubberless high temperature technology, it offers higher specified turn off commutation and noise immunity levels up to the T<sub>i</sub> max.

The T3035H-8G safely optimizes the control of the hardest universal motors, heaters and inductive loads for industrial control and home appliances.

Available in D<sup>2</sup>PAK package, it is suitable for compact SMD designs on surface mount boards or insulated metal substrate or direct bond copper boards.

## 1 Characteristics

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Symbol	Parameter	Value	Unit	
I <sub>T(RMS)</sub>	RMS on-state current (full sine wave) $T_c = 121 \degree C$		30	А
	Non repetitive surge peak on-state current	t <sub>p</sub> = 16.7 ms	283	A
I <sub>TSM</sub>	(full cycle, T <sub>j</sub> initial = 25 °C)	t <sub>p</sub> = 20 ms	270	
l <sup>2</sup> t	I <sup>2</sup> t value for fusing	t <sub>p</sub> = 10 ms	482	A <sup>2</sup> s
dl/dt	Critical rate of rise of on-state current, $I_G = 2 \times I_{GT}$ , tr $\leq 100 \text{ ns}$ , f = 100 Hz	100	A/µs	
V <sub>DRM</sub> /V <sub>RRM</sub>	Repetitive peak off-state voltage	800	V	
V <sub>DSM</sub> /V <sub>RSM</sub>	Non Repetitive peak off-state voltage	900	V	
I <sub>GM</sub>	Peak gate current	4	А	
P <sub>GM</sub>	Maximum gate power dissipation $t_p = 20 \ \mu s, T_j = 150 \ ^{\circ}C$		5	W
P <sub>G(AV)</sub>	Average gate power dissipation T <sub>j</sub> = 150 °C		1	W
T <sub>stg</sub>	Storage temperature range	-40 to +150	°C	
Tj	Operating junction temperature range	-40 to +150	°C	

#### Table 1. Absolute maximum ratings (limiting values)

#### Table 2. Electrical characteristics (T<sub>j</sub> = 25 °C, unless otherwise specified)

Symbol	Test conditio	Quadrants		Value	Unit	
1	$V_D$ = 12 V, R <sub>L</sub> = 30 $\Omega$		1 - 11 - 111	Min.	5	mA
I <sub>GT</sub>	$V_D$ = 12 V, $R_L$ = 30 $\Omega$		1 - 11 - 111	Max.	35	mA
V <sub>GT</sub>	$V_D$ = 12 V, R <sub>L</sub> = 30 $\Omega$		1 - 11 - 111	Max.	1.3	V
V <sub>GD</sub>	$V_D$ = $V_{DRM}$ , $R_L$ = 3.3 k $\Omega$	T <sub>j</sub> = 150 °C	1 - 11 - 111	Min.	0.15	V
I.	$I_L$ $I_G = 1.2 \times I_{GT}$		I - III	Max.	75	mA
۰L			II	Max.	90	mA
I <sub>H</sub> <sup>(1)</sup>	$I_T$ = 500 mA, gate open		Max.	60	mA	
dV/dt (1)	V <sub>D</sub> = 536 V, gate open		T <sub>j</sub> = 150 °C	Min.	2000	V/µs
(dl/dt)c (1)	Without snubber network		T <sub>j</sub> = 150 °C	Min.	25	A/ms

1. For both polarities of A2 referenced to A1.

#### Table 3. Static characteristics

Symbol	Test conditions	Тj		Value	Unit
V <sub>TM</sub> <sup>(1)</sup>	I <sub>T</sub> = 42 A, t <sub>p</sub> = 380 μs	25 °C	Max.	1.55	V
V <sub>TO</sub> <sup>(1)</sup>	Threshold voltage	150 °C	Max.	0.83	V
R <sub>D</sub> <sup>(1)</sup>	Dynamic resistance	150 °C	Max.	16	mΩ
	$V_{D} = V_{R} = V_{DRM} = V_{RRM}$	25 °C	Max.	2.5	μA
I <sub>DRM</sub> /I <sub>RRM</sub>	VD - VR - VDRM - VRRM	150°C	Wax.	8.5	mA
	$V_D = V_R = 400 V$ , peak voltage	150 °C	Max.	3.6	mA

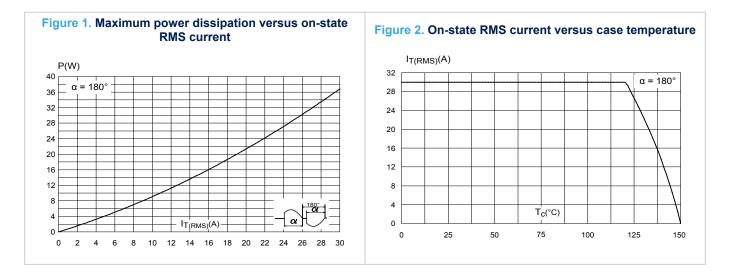
1. For both polarities of A2 referenced to A1.

#### Table 4. Thermal resistance

Symbol	Parameter	Value	Unit	
R <sub>th(j-c)</sub>	Junction to case (AC)	Max.	0.8	°C/W
Rth(j-a)	Junction to ambient ( $S_{CU}^{(1)} = 2 \text{ cm}^2$ )	Тур.	45	°C/W

1. Scu : copper pad surface under tab, 35 μm copper thickness on FR4 PCB.

### 1.1 Characteristics (curves)



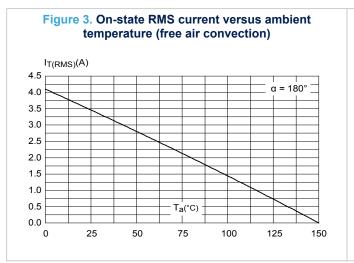
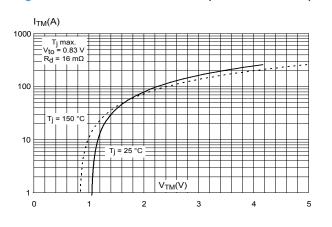
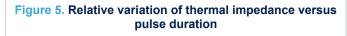
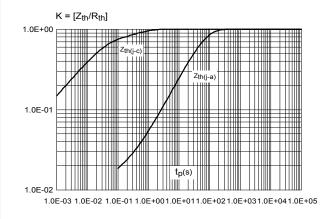
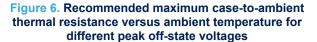


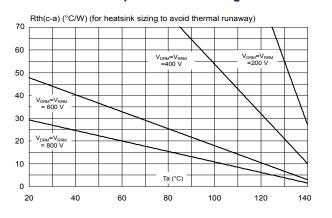
Figure 4. On-state characteristics (maximum values)





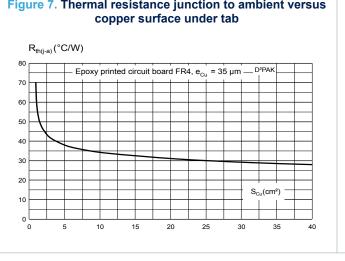












## Figure 7. Thermal resistance junction to ambient versus

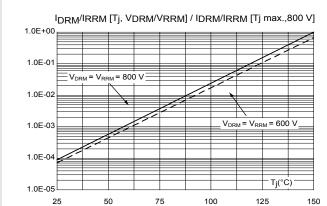


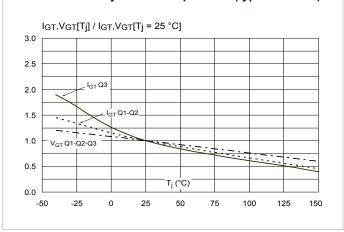
Figure 8. Relative variation of leakage current versus

junction temperature for different values of blocking

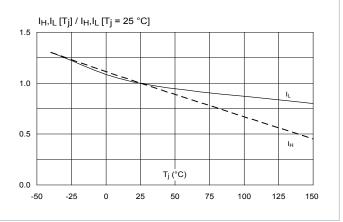
voltage

## Figure 9. Relative variation of gate trigger voltage and

current versus junction temperature (typical values)



#### Figure 10. Relative variation of holding current and latching current versus junction temperature (typical values)



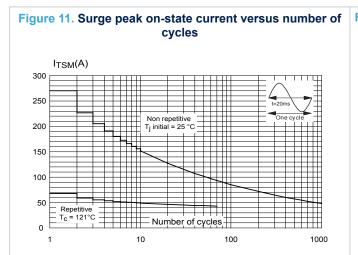
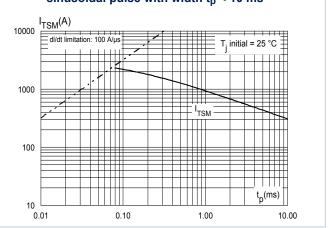
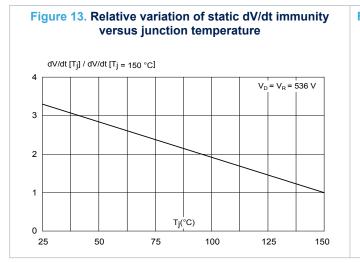


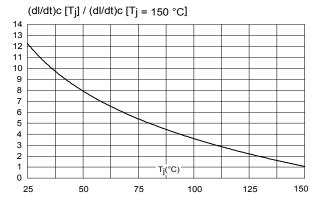
Figure 12. Non repetitive surge peak on-state current for a sinusoidal pulse with width t<sub>p</sub> < 10 ms







## Figure 14. Relative variation of critical rate of decrease of main current versus junction temperature



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#### **Package information** 2

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In order to meet environmental requirements, ST offers these devices in different grades of ECOPACK packages, depending on their level of environmental compliance. ECOPACK specifications, grade definitions and product status are available at: www.st.com. ECOPACK is an ST trademark.

#### D<sup>2</sup>PAK package information 2.1

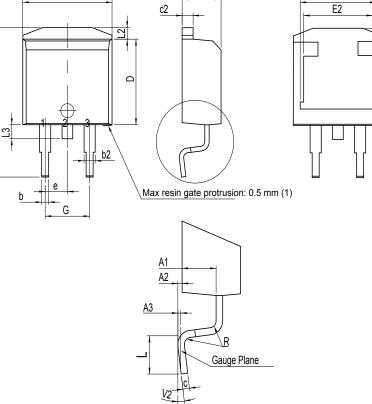
ECOPACK2 compliant

т

- Lead-free package leads finishing
- Molding compound resin is halogen-free and meets UL94 flammability standard level V0

# Е E1 E2





(1) Resin gate is accepted in each of position shown on the drawing, or their symmetrical.

				Dimensions			
Ref.		Millimeters		Inches <sup>(1)</sup>			
	Min.	Тур.	Max.	Min.	Тур.	Max.	
А	4.30		4.60	0.1693		0.1811	
A1	2.49		2.69	0.0980		0.1059	
A2	0.03		0.23	0.0012		0.0091	
A3		0.25			0.0098		
b	0.70		0.93	0.0276		0.0366	
b2	1.25		1.7	0.0492		0.0669	
С	0.45		0.60	0.0177		0.0236	
c2	1.21		1.36	0.0476		0.0535	
D	8.95		9.35	0.3524		0.3681	
D1	7.50		8.00	0.2953		0.3150	
D2	1.30		1.70	0.0512		0.0669	
е	2.54			0.10000			
Е	10.00		10.28	0.3937		0.4047	
E1	8.30		8.70	0.3268		0.3425	
E2	6.85		7.25	0.2697		0.2854	
G	4.88		5.28	0.1921		0.2079	
Н	15		15.85	0.5906		0.6240	
L	1.78		2.28	0.0701		0.0898	
L2	1.19		1.40	0.0468		0.0551	
L3	1.40		1.75	0.0551		0.0689	
R		0.40			0.0157		
V2 <sup>(2)</sup>	0°		8°	0°		8°	

#### Table 5. D<sup>2</sup>PAK package mechanical data

1. Dimensions in inches are given for reference only

2. Degrees

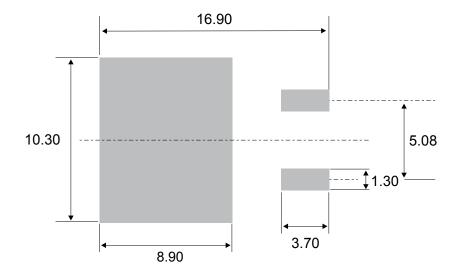
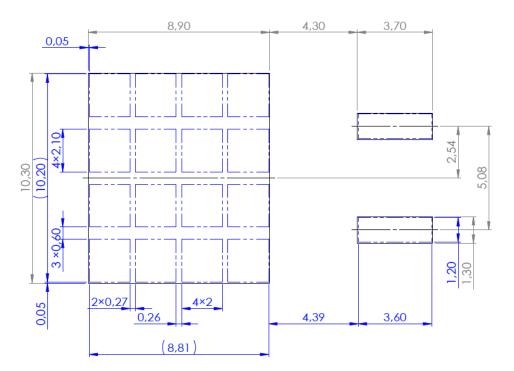


Figure 16. D<sup>2</sup>PAK recommended footprint (dimensions are in mm)

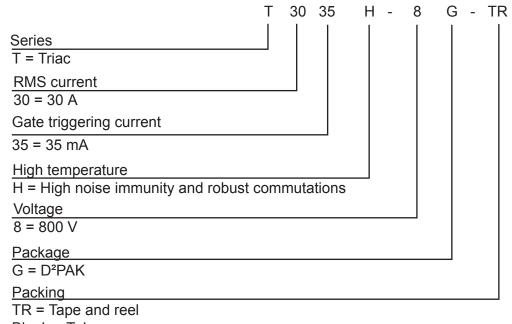




## **3** Ordering information

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#### Figure 18. Ordering information scheme



Blank = Tube

#### Table 6. Ordering information

Order code	Marking	Package	Weight	Base qty.	Delivery mode
T3035H-8G-TR	T3035H-8G		160	1000	Tape and reel 13"
T3035H-8G	130330-60	D²PAK 1.6 g		50	Tube

## **Revision history**

Date	Version	Changes
27-Jul-2018	1	Initial release.
25-Jun-2019	2	Minor text changed.
20-Dec-2019	3	Added Figure 7 and Figure 12.
15-Jan-2020	4	Updated Table 6.
21-Dec-2020	5	Updated general description. Inserted STPOWER logo.

#### Table 7. Document revision history

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